

MOSFET

OptiMOS[™] 3 Power-Transistor, 60 V

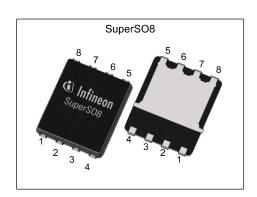
Features

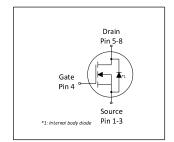
- Ideal for high frequency switching and sync. rec.
- Optimized technology for DC/DC converters
 Excellent gate charge x R_{DS(on)} product (FOM)
 Superior thermal resistance
- N-channel, logic level100% avalanche tested

- Pb-free plating; RoHS compliant
 Qualified according to JEDEC¹⁾ for target applications
 Halogen-free according to IEC61249-2-21



| Table : Itely : errormance : arametere | | | | | | | |
|--|-------|------|--|--|--|--|--|
| Parameter | Value | Unit | | | | | |
| $V_{ m DS}$ | 60 | V | | | | | |
| R _{DS(on),max} | 10 | mΩ | | | | | |
| I _D | 55 | A | | | | | |











| Type / Ordering Code | Package | Marking | Related Links |
|----------------------|------------|----------|---------------|
| BSC100N06LS3 G | PG-TDSON-8 | 100N06LS | - |



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1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

| D | 0 | | Value | s | | |
|--|-----------------------------------|------------------|------------------|----------------------------|------|---|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Continuous drain current ¹⁾ | ID | - - - - | - - - - | 55 36 41 26 12 | A | $V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =4.5 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =4.5 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10V, $T_{\rm A}$ =25°C, $R_{\rm thJA}$ =50K/W ²⁾ |
| Pulsed drain current ³⁾ | I _{D,pulse} | - | - | 220 | Α | T _C =25 °C |
| Avalanche energy, single pulse ⁴⁾ | E _{AS} | - | - | 22 | mJ | $I_{\rm D}$ =50 A, $R_{\rm GS}$ =25 Ω |
| Gate source voltage | V _{GS} | -20 | - | 20 | V | - |
| Power dissipation | P _{tot} | - | - | 50 2.5 | W | T _C =25 °C T _A =25 °C, R _{thJA} =50 K/W ²⁾ |
| Operating and storage temperature | T _j , T _{stg} | -55 | - | 150 | °C | IEC climatic category; DIN IEC 68-1: 55/150/56 |

2 Thermal characteristics

Table 3 **Thermal characteristics**

| Parameter | Cymph ol | Values | | | 11 | Note / Test Condition |
|--|-------------------|--------|------|------|------|-----------------------|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Thermal resistance, junction - case | R_{thJC} | - | - | 2.5 | K/W | - |
| Device on PCB, minimal footprint | R_{thJA} | - | - | 62 | K/W | - |
| Device on PCB, 6 cm ² cooling area ²⁾ | R _{thJA} | _ | _ | 50 | K/W | - |

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual

environmental conditions.

2) Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm2 (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

4) See Diagram 13 for more detailed information



3 Electrical characteristics at T_j =25 °C, unless otherwise specified

Table 4 **Static characteristics**

| Parameter. | 0 | | Values | | | N |
|----------------------------------|-----------------------|------|-------------|------------|------|---|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Drain-source breakdown voltage | V _{(BR)DSS} | 60 | - | - | V | $V_{\rm GS}$ =0 V, $I_{\rm D}$ =1 mA |
| Gate threshold voltage | $V_{\mathrm{GS(th)}}$ | 1.2 | 1.7 | 2.2 | V | $V_{\rm DS}$ = $V_{\rm GS}$, $I_{\rm D}$ =23 μA |
| Zero gate voltage drain current | $I_{ m DSS}$ | - | 0.1 10 | 1.0 100 | μA | V _{DS} =60 V, V _{GS} =0 V, T _j =25 °C V _{DS} =60 V, V _{GS} =0 V, T _j =125 °C |
| Gate-source leakage current | I _{GSS} | - | 10 | 100 | nA | V _{GS} =20 V, V _{DS} =0 V |
| Drain-source on-state resistance | R _{DS(on)} | - | 11.8 7.8 | 17.9 10 | mΩ | V _{GS} =4.5 V, I _D =25 A V _{GS} =10 V, I _D =50 A |
| Gate resistance | R _G | - | 1.3 | - | Ω | - |
| Transconductance | g_{fs} | 32 | 63 | - | S | V _{DS} >2 I _D R _{DS(on)max} , I _D =50 A |

 Table 5
 Dynamic characteristics

| Davamatav | Symbol | Values | | | 11 | Note / Test Condition |
|----------------------------------|------------------|--------|------|------|------|--|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Input capacitance ¹⁾ | C _{iss} | - | 2600 | 3500 | pF | V _{GS} =0 V, V _{DS} =30 V, f=1 MHz |
| Output capacitance ¹⁾ | Coss | - | 500 | 660 | pF | V _{GS} =0 V, V _{DS} =30 V, <i>f</i> =1 MHz |
| Reverse transfer capacitance | C _{rss} | - | 24 | - | pF | V _{GS} =0 V, V _{DS} =30 V, f=1 MHz |
| Turn-on delay time | $t_{\sf d(on)}$ | - | 8 | - | ns | $V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =3 Ω |
| Rise time | t _r | - | 58 | - | ns | $V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =3 Ω |
| Turn-off delay time | $t_{ m d(off)}$ | - | 19 | - | ns | $V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =3 Ω |
| Fall time | t _f | - | 8 | - | ns | $V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =3 Ω |

Gate charge characteristics²⁾ Table 6

| Parameter | Symbol | Values | | | Unit | Note / Took Condition |
|---------------------------------|----------------------|--------|------|------|-------|---|
| Farameter | Symbol | Min. | Typ. | Max. | Ullit | Note / Test Condition |
| Gate to source charge | Q_{gs} | - | 10 | - | nC | V_{DD} =30 V, I_{D} =50 A, V_{GS} =0 to 4.5 V |
| Gate charge at threshold | $Q_{g(th)}$ | - | 4 | - | nC | V_{DD} =30 V, I_{D} =50 A, V_{GS} =0 to 4.5 V |
| Gate to drain charge | $Q_{ m gd}$ | - | 3 | - | nC | $V_{\rm DD}$ =30 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 4.5 V |
| Switching charge | Q _{sw} | - | 9 | - | nC | V_{DD} =30 V, I_{D} =50 A, V_{GS} =0 to 4.5 V |
| Gate charge total ¹⁾ | Qg | - | 15 | 20 | nC | V_{DD} =30 V, I_{D} =50 A, V_{GS} =0 to 4.5 V |
| Gate plateau voltage | V _{plateau} | - | 4.0 | - | V | V_{DD} =30 V, I_{D} =50 A, V_{GS} =0 to 4.5 V |
| Gate charge total ¹⁾ | Qg | - | 34 | 45 | nC | V_{DD} =30 V, I_{D} =50 A, V_{GS} =0 to 10 V |
| Output charge ¹⁾ | Q _{oss} | _ | 25 | 33 | nC | V _{DD} =30 V, V _{GS} =0 V |

Defined by design. Not subject to production test See "Gate charge waveforms" for parameter definition

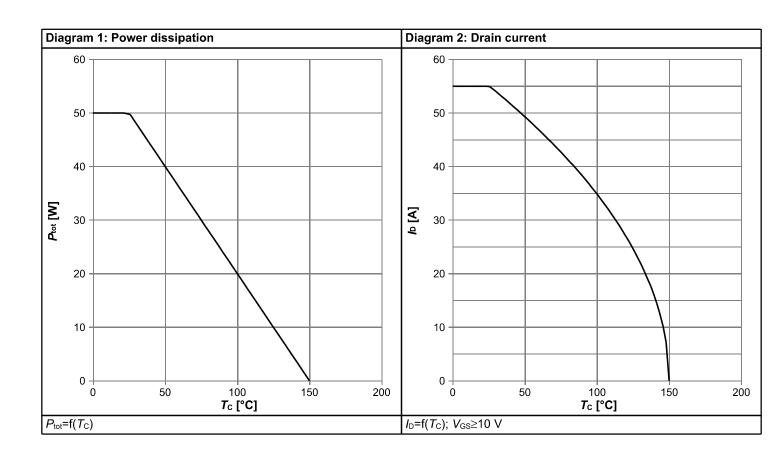


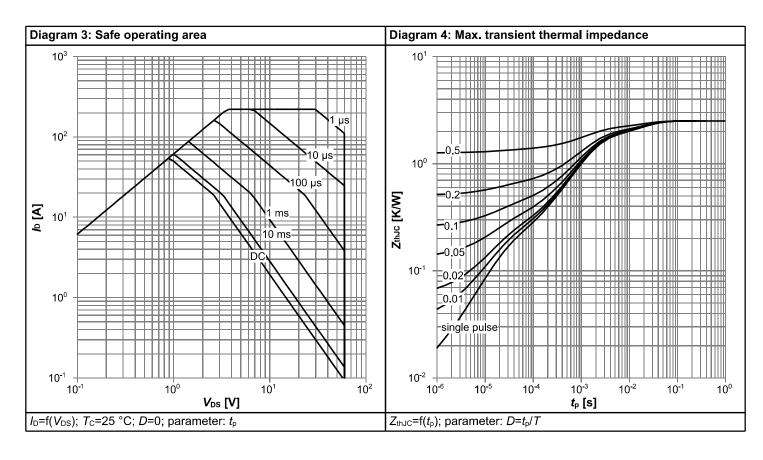
Table 7 Reverse diode

| Parameter | Sumb al | Values | | | 11:4 | Note / Total Constitution |
|----------------------------------|----------------------|--------|------|------|------|---|
| | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Diode continuous forward current | Is | - | - | 45 | Α | T _C =25 °C |
| Diode pulse current | I _{S,pulse} | - | - | 220 | Α | <i>T</i> _C =25 °C |
| Diode forward voltage | V _{SD} | - | 0.92 | 1.2 | V | V _{GS} =0 V, I _F =50 A, T _j =25 °C |
| Reverse recovery time | t _{rr} | - | 35 | - | ns | V _R =30 V, I _F =50A, di _F /dt=100 A/μs |
| Reverse recovery charge | Q _{rr} | - | 36 | - | nC | V_R =30 V, I_F =50A, di_F/dt =100 A/ μ s |

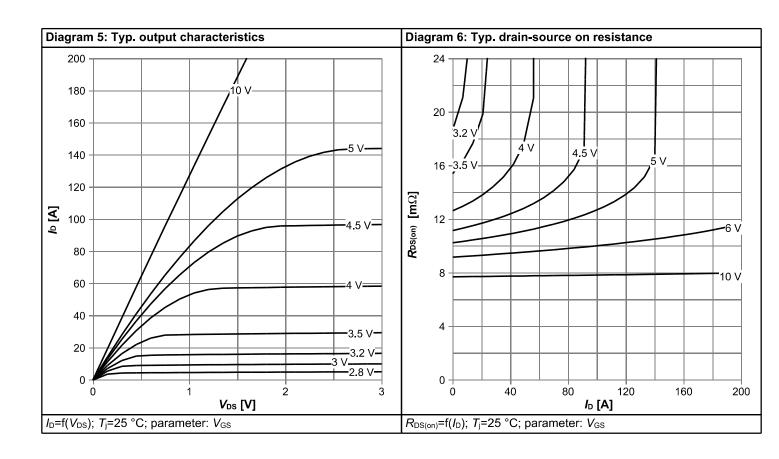


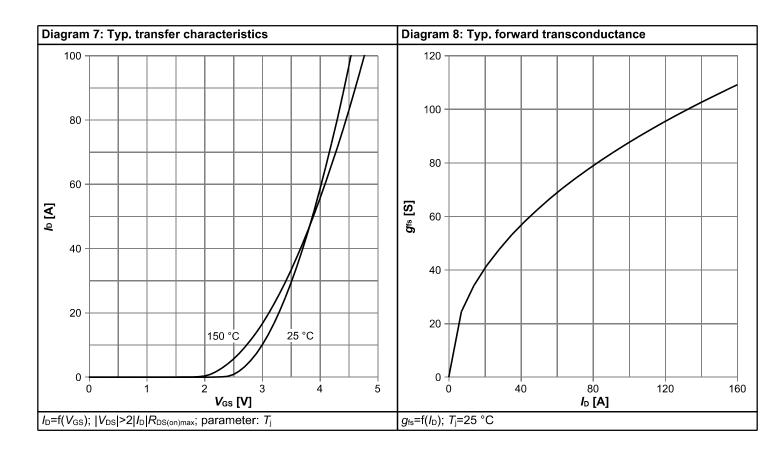
4 Electrical characteristics diagrams



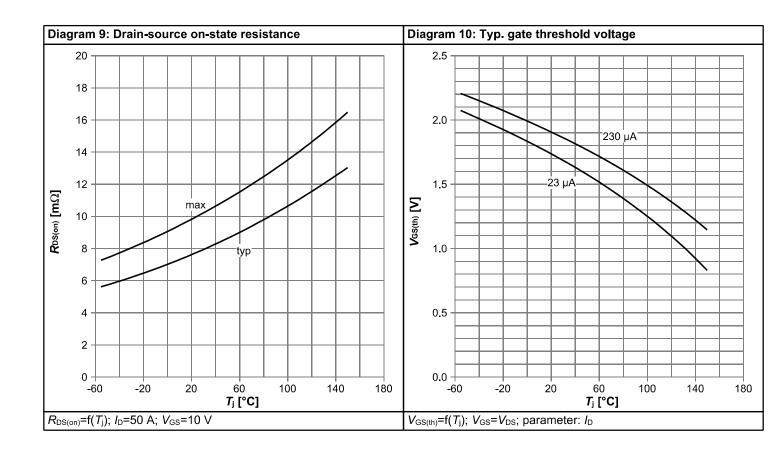


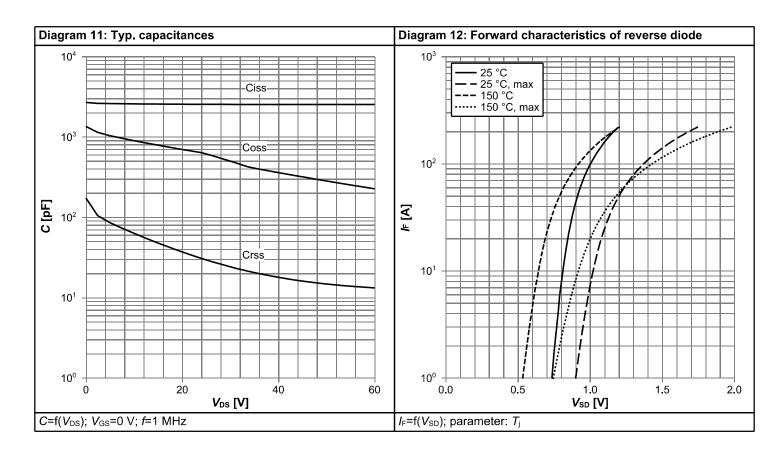




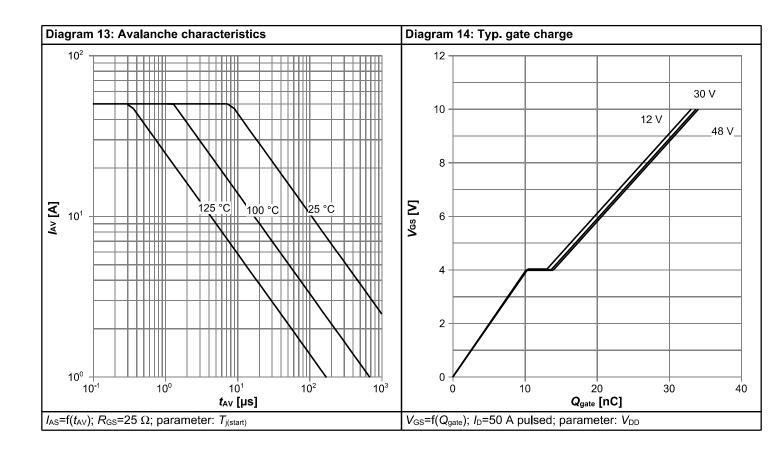


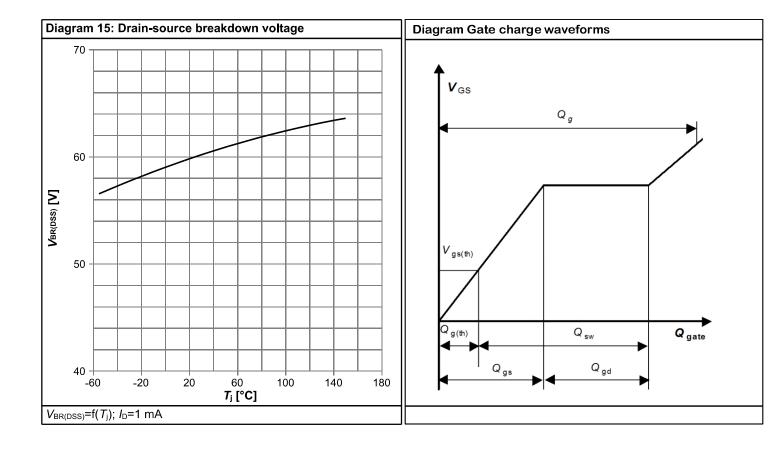






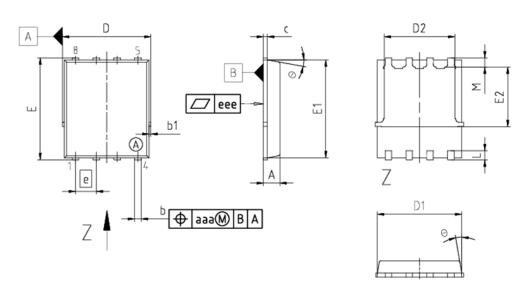








5 Package Outlines



| DIM | MILLIM | ETERS | | | | |
|-----|-----------|-------|--|--|--|--|
| DIM | MIN | MAX | | | | |
| Α | 0.90 | 1.10 | | | | |
| b | 0.31 | 0.54 | | | | |
| b1 | 0.02 | 0.22 | | | | |
| С | 0.15 | 0.35 | | | | |
| D | 5.15 | 5.49 | | | | |
| D1 | 4.95 | 5.35 | | | | |
| D2 | 3.70 | 4.40 | | | | |
| E | 5.95 | 6.35 | | | | |
| E1 | 5.70 | 6.10 | | | | |
| E2 | 3.40 3.80 | | | | | |
| e | 1.27 | | | | | |
| N | 8 | | | | | |
| L | 0.45 0.71 | | | | | |
| М | 0.45 0.75 | | | | | |
| Θ | 8.5° 12° | | | | | |
| aaa | 0.25 | | | | | |
| eee | 0.08 | | | | | |

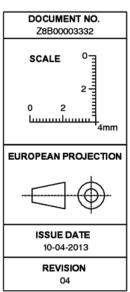


Figure 1 Outline PG-TDSON-8, dimensions in mm



Revision History

BSC100N06LS3 G

Revision: 2021-07-01, Rev. 2.4

Previous Revision

| Revision | Date | Subjects (major changes since last revision) |
|----------|------------|--|
| 2.4 | 2021-07-01 | Update current rating and footnotes |

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